

DSA30C200IB

preliminary

 $V_{RRM} = 200V$

 $I_{FAV} = 2x \quad 15A$

 $V_F = 0.78V$

High Performance Schottky Diode Low Loss and Soft Recovery Common Cathode

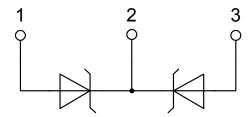
Schottky Diode Gen²

Part number

DSA30C200IB



Backside: cathode



Features / Advantages:

- Very low Vf
- Extremely low switching losses
- Low Irm values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

Package: TO-262 (I2Pak)

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0





preliminary

Schottky				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RSM}	max. non-repetitive reverse blocki	ng voltage	$T_{VJ} = 25^{\circ}C$			200	V
V _{RRM}	max. repetitive reverse blocking v	oltage	$T_{VJ} = 25^{\circ}C$			200	V
I _R	reverse current, drain current	V _R = 200 V	$T_{VJ} = 25^{\circ}C$			250	μΑ
		$V_R = 200 V$	$T_{VJ} = 125^{\circ}C$			2.5	mΑ
V _F	forward voltage drop	I _F = 15 A	$T_{VJ} = 25^{\circ}C$			0.94	V
		$I_F = 30 A$				1.10	٧
		I _F = 15 A	T _{VJ} = 125°C			0.78	V
		$I_F = 30 A$				0.95	V
I _{FAV}	average forward current	T _c = 155°C	T _{vJ} = 175°C			15	Α
		rectangular d = 0.5					
V _{F0}	threshold voltage		T _{vJ} = 175°C			0.53	V
r _F	slope resistance				10.8	mΩ	
R _{thJC}	thermal resistance junction to case	е				1.75	K/W
R _{thCH}	thermal resistance case to heatsing	nk			0.50		K/W
P _{tot}	total power dissipation		$T_{\rm C}$ = 25°C			85	W
I _{FSM}	max. forward surge current	$t = 10 \text{ ms}$; (50 Hz), sine; $V_R = 0 \text{ V}$	$T_{VJ} = 45^{\circ}C$			320	Α
CJ	junction capacitance	V _R = 48 V f = 1 MHz	$T_{VJ} = 25^{\circ}C$		47		pF

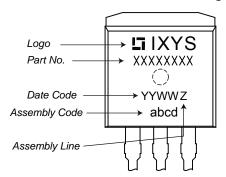




preliminary

Package TO-262 (I2Pak)			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I _{RMS}	RMS current	per terminal 1)			35	Α
T _{VJ}	virtual junction temperature		-55		175	°C
T _{op}	operation temperature		-55		150	°C
T _{stg}	storage temperature		-55		150	°C
Weight				1.5		g
F _c	mounting force with clip		20		60	Ν

Product Marking



Part number

D = Diode

S = Schottky Diode

A = low VF

30 = Current Rating [A]

C = Common Cathode

200 = Reverse Voltage [V] IB = TO-262 (I2Pak) (3)

Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DSA30C200IB	DSA30C200IB	Tube	50	512200

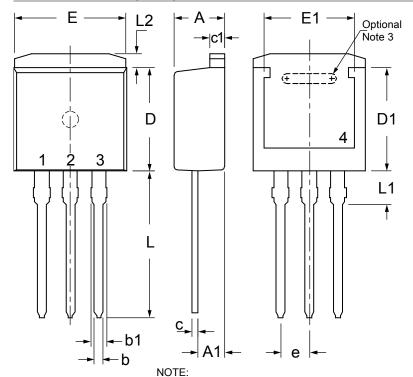
Similar Part	Package	Voltage class
DSA30C200PB	TO-220AB (3)	200

Equiv	alent Circuits for	Simulation	* on die level	T _{VJ} = 175 °C
$I \rightarrow V_0$	R_0	Schottky		
V _{0 max}	threshold voltage	0.53		V
$R_{0\text{max}}$	slope resistance *	7.6		$m\Omega$



preliminary

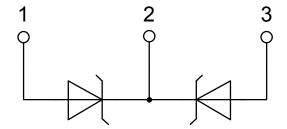
Outlines TO-262 (I2Pak)



SYM	INCHES		MILLIMETERS		
2114	MIN	MAX	MIN	MAX	
Α	160،	190،	4.06	4.83	
A1	.080	.110	2.03	2.79	
b	.025	.035	0.64	0.88	
b1	.025	.039	1.14	1.40	
С	.018	.025	0.46	0.64	
с1	.045	.055	1.14	1.40	
D	.340	.380	8,64	9,65	
D1	.270	.290	6.86	7.37	
Ε	.380	.405	9.65	10.29	
E1	.245	.320	6.22	8.13	
е	.100 BSC		2.54 BSC		
L	.500	.560	12.70	14.22	
L1	.100	.125	2.54	3.18	
L2	.040	.055	1.02	1,40	



- 1. This drawing will meet all dimensions requirement of JEDEC outline TO-262 AA.
- 2. All metal surface are matte pure tin plated except trimmed area.
- 3. Inter locking slot depends upon frame type.



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

IXYS:

DSA30C200IB